

### FEATURES

**Matched Offset Voltage**  
**Matched Offset Voltage Over Temperature**  
**Matched Bias Current**  
**Crosstalk: -124 dB @ 1 kHz**  
**Low Bias Current: 35 pA max Warmed Up**  
**Low Offset Voltage: 500  $\mu$ V max**  
**Low Input Voltage Noise: 2  $\mu$ V p-p**  
**High Open Loop Gain**  
**Low Quiescent Current: 2.8 mA max**  
**Low Total Harmonic Distortion**  
**Standard Dual Amplifier Pin Out**  
**Available in Hermetic Metal Can Package and Chip Form**  
**MIL-STD-883B Processing Available**  
**Single Version Available: AD542**

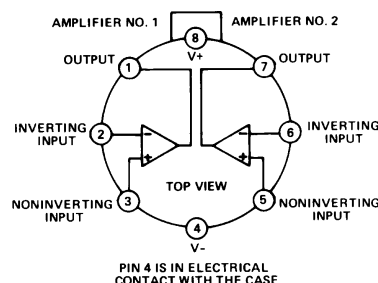
### PRODUCT DESCRIPTION

The AD642 is a pair of matched high speed monolithic BiFET operational amplifier fabricated with the most advanced bipolar, JFET and laser trimming technologies. The AD642 offers matched bias currents that are significantly lower than currently available monolithic dual FET input operational amplifiers: 35 pA max matched to 25 pA for the AD642K and L; 75 pA max, matched to 35 pA for the AD642J and S. In addition, the offset voltage is laser trimmed to less than 0.5 mV and matched to 0.25 mV for the AD642L, 1.0 mV and matched to 0.5 mV for the AD642K, utilizing Analog's laser-wafer trimming (LWT) process.

The tight matching and temperature tracking between the operational amplifiers is achieved by ion-implanted JFETs and laser-wafer trimming. Ion-implantation permits the fabrication of precision, matched JFETs on a monolithic bipolar chip. The optimizes the process to product matched bias currents which have lower initial bias currents than other popular BiFET op amps. Laser-wafer trimming each amplifier's input offset voltage assures tight initial match and combined with superior IC processing guarantees offset voltage tracking over the temperature range.

The AD642 is recommended for applications in which excellent ac and dc performance is required. The matched amplifiers provide a low-cost solution for true instrumentation amplifiers, log ratio amplifiers, and output amplifiers for four quadrant multiplying D/A converters such as the AD7541.

### PIN CONFIGURATION



The AD642 is available in four versions: the "J", "K" and "L," all specified over the 0°C to +70°C temperature range and one version, "S," over the -55°C to +125°C extended operating temperature range. All devices are packaged in the hermetically-sealed, TO-99 metal can or available in chip form.

### PRODUCT HIGHLIGHTS

1. The AD642 has tight matching specifications to ensure high performance, eliminating the need to match individual devices.
2. Analog Devices, unlike some manufacturers, specifies each device for the maximum bias current at either input in the warmed-up condition, thus assuring the user that the AD642 will meet its published specifications in actual use.
3. Laser-wafer-trimming reduces offset voltage to as low as 0.5 mV max and matched side to side to 0.25 mV (AD642L), thus eliminating the need for external nulling.
4. Low voltage noise (2  $\mu$ V, p-p), and high open loop gain enhance the AD642's performance as a precision op amp.
5. The standard dual amplifier pin out allows the AD642 to replace lower performance duals without redesign.
6. The AD642 is available in chip form.

### REV. 0

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# AD642—SPECIFICATIONS (@ + 25°C, and $V_S = \pm 15$ V dc)

Model	Min	AD642J Typ	Max	Min	AD642K Typ	Max	Min	AD642L Typ	Max	Min	AD642S Typ	Max	Unit
OPEN LOOP GAIN $V_O = \pm 10$ V, $R_L \geq 2$ k $\Omega$ $T_{MIN}$ to $T_{MAX}$ , $R_L = 2$ k $\Omega$	<b>100,000</b>			<b>250,000</b>			<b>250,000</b>			<b>250,000</b>			V/V V/V
OUTPUT CHARACTERISTICS Voltage @ $R_L = 2$ k $\Omega$ , $T_{MIN}$ to $T_{MAX}$ Voltage @ $R_L = 10$ k $\Omega$ , $T_{MIN}$ to $T_{MAX}$ Short Circuit Current	$\pm 10$ $\pm 12$	$\pm 12$ $\pm 13$		$\pm 10$ $\pm 12$	$\pm 12$ $\pm 13$		$\pm 10$ $\pm 12$	$\pm 12$ $\pm 13$		$\pm 10$ $\pm 12$	$\pm 12$ $\pm 13$		V V mA
FREQUENCY RESPONSE Unity Gain Small Signal Full Power Response Slew Rate, Unity Gain		1.0 50			1.0 50			1.0 50			1.0 50		MHz kHz V/ $\mu$ s
INPUT OFFSET VOLTAGE <sup>1</sup> Initial Offset Input Offset Voltage $T_{MIN}$ to $T_{MAX}$ Input Offset Voltage vs. Supply, $T_{MIN}$ to $T_{MAX}$			<b>2.0</b> 3.5		<b>1.0</b> 2.0			<b>0.5</b> 1.0			<b>1.0</b> 3.5		mV mV $\mu$ V/V
INPUT BIAS CURRENT <sup>2</sup> Either Input Offset Current		10 5	75		10 2	35		10 2	35		10 2	35	pA
MATCHING CHARACTERISTICS <sup>3</sup> Input Offset Voltage Input Offset Voltage $T_{MIN}$ to $T_{MAX}$ Input Bias Current Crosstalk			<b>1.0</b> 3.5 35		<b>0.5</b> 2.0 25			<b>0.25</b> 1.0 25			<b>0.5</b> 3.5 35		mV mV pA dB
INPUT IMPEDANCE Differential Common Mode		$10^{12} \parallel 6$ $10^{12} \parallel 6$			$10^{12} \parallel 6$ $10^{12} \parallel 6$			$10^{12} \parallel 6$ $10^{12} \parallel 6$			$10^{12} \parallel 6$ $10^{12} \parallel 6$		M $\Omega \parallel$ pF M $\Omega \parallel$ pF
INPUT VOLTAGE RANGE Differential <sup>4</sup> Common Mode Common-Mode Rejection		$\pm 20$ $\pm 12$			$\pm 20$ $\pm 12$			$\pm 20$ $\pm 12$			$\pm 20$ $\pm 12$		V V dB
INPUT NOISE Voltage 0.1 Hz to 10 Hz $f = 10$ Hz $f = 100$ Hz $f = 1$ kHz $f = 10$ kHz		2 70 45 30 25			2 70 45 30 25			2 70 45 30 25			2 70 45 30 25		$\mu$ V p-p nV/ $\sqrt{\text{Hz}}$ nV/ $\sqrt{\text{Hz}}$ nV/ $\sqrt{\text{Hz}}$ nV/ $\sqrt{\text{Hz}}$
POWER SUPPLY Rated Performance Operating Quiescent Current	$\pm 5$	$\pm 15$	$\pm 18$ 2.8	$\pm 5$	$\pm 15$	$\pm 15$ 2.8	$\pm 5$	$\pm 15$	$\pm 15$ 2.8	$\pm 5$	$\pm 15$	$\pm 15$ 2.8	V V mA
TRANSISTOR COUNT		58			58			58			58		
PACKAGE OPTION TO-99 Style (H-08B)		AD642JH			AD642KH			AD642LH			AD642SH		

## NOTES

<sup>1</sup>Input Offset Voltage specifications are guaranteed after 5 minutes of operation at  $T_A = +25^\circ\text{C}$ .

<sup>2</sup>Bias Current specifications are guaranteed at maximum at either input after 5 minutes of operation at  $T_A = +25^\circ\text{C}$ . For higher temperatures, the current doublers every  $10^\circ\text{C}$ .

<sup>3</sup>Matching is defined as their difference between parameters of the two amplifiers.

<sup>4</sup>Defined as the maximum safe voltage between inputs, such that neither exceeds  $\pm 10$  V from ground.

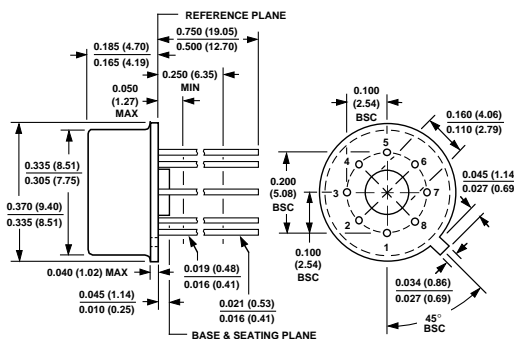
Specifications subject to change without notice.

Specifications shown in **boldface** are tested on all production units at final electrical test. Results from those tests are used to calculate outgoing quality levels. All min and max specifications are guaranteed, although only those shown in boldface are tested on all production units.

## OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

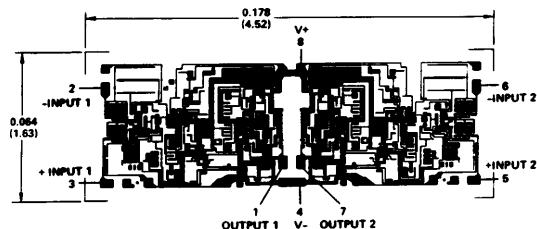
### TO-99



## METALIZATION PHOTOGRAPHIC

Contact factory for latest dimensions.

Dimensions shown in inches and (mm).



# Typical Characteristics—AD642

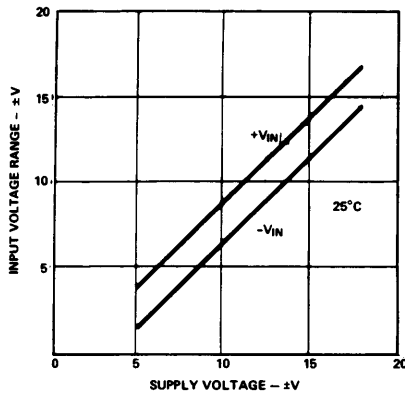


Figure 1. Input Voltage Range vs. Supply Voltage

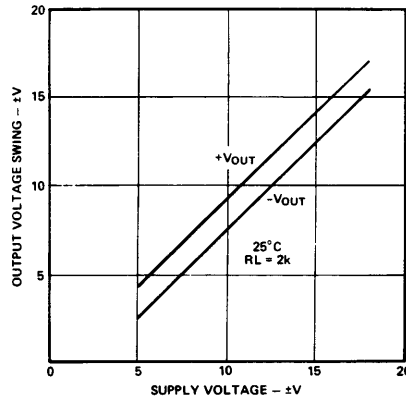


Figure 2. Output Voltage Swing vs. Supply Voltage

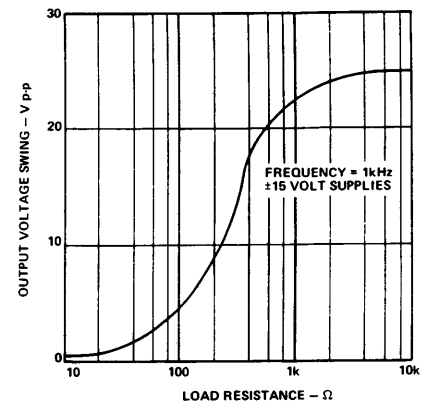


Figure 3. Output Voltage Swing vs. Load Resistance

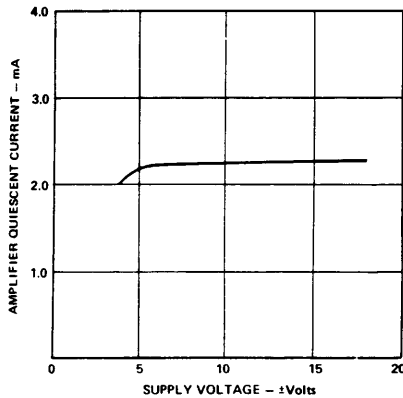


Figure 4. Quiescent Current vs. Supply Voltage

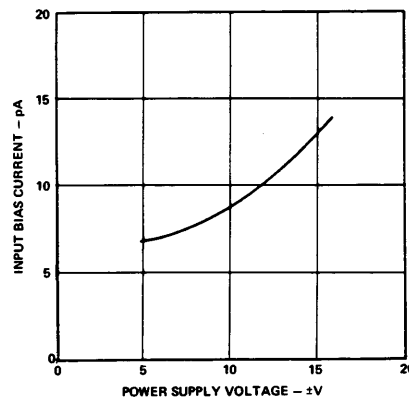


Figure 5. Input Bias Current vs. Power Supply Voltage

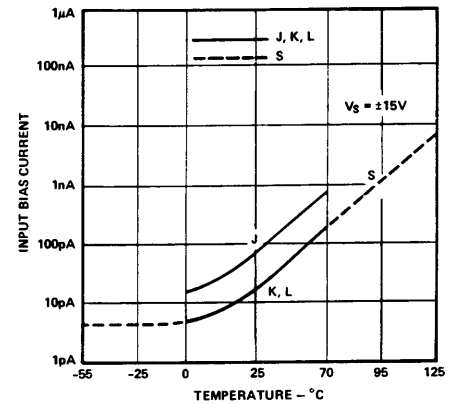


Figure 6. Input Bias Current vs. Temperature

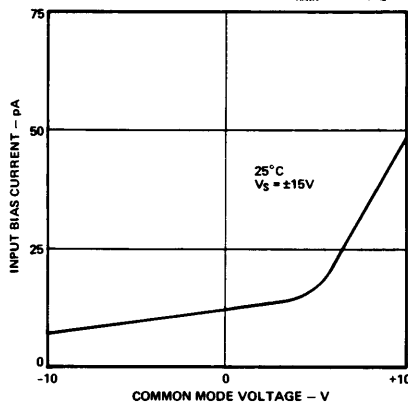


Figure 7. Input Bias Current vs. CMV

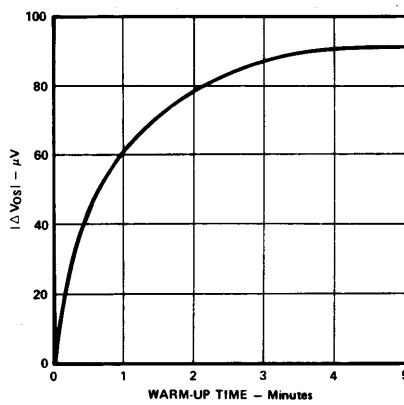


Figure 8. Change in Offset vs. Warm-Up Time

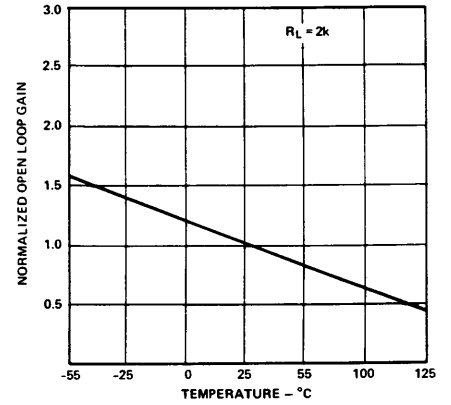


Figure 9. Open Loop vs. Temperature

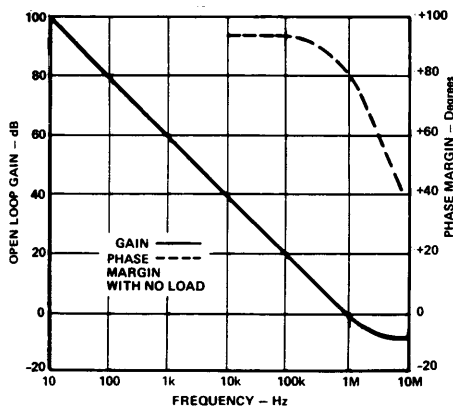


Figure 10. Open Loop Frequency Response

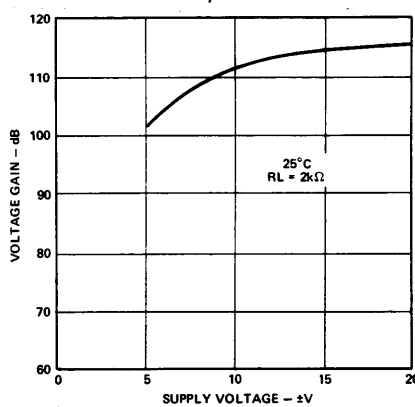


Figure 11. Open Loop Voltage Gain vs. Supply Voltage

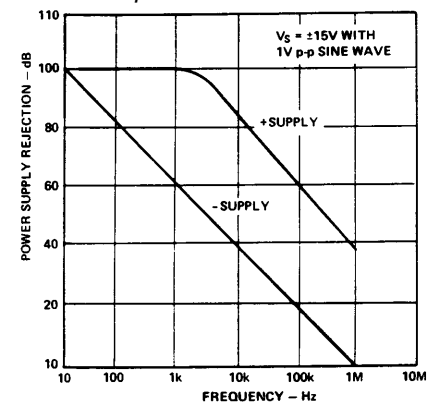


Figure 12. Power Supply Rejection vs. Frequency

# AD642

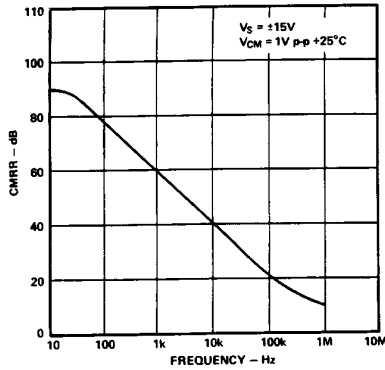


Figure 13. Common-Mode Rejection Ratio vs. Frequency

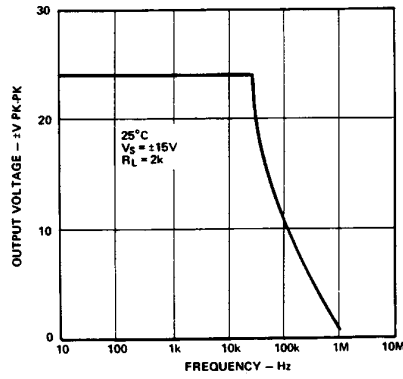


Figure 14. Large Signal Frequency Response

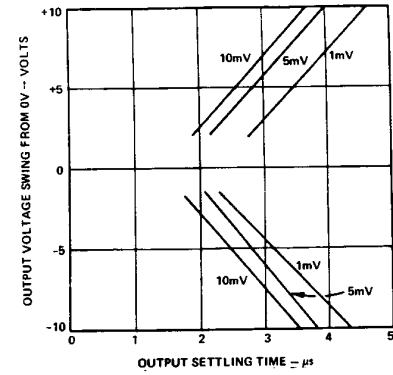


Figure 15. Output Swing and Error vs. Output Settling Time (Circuit of Figure 23)

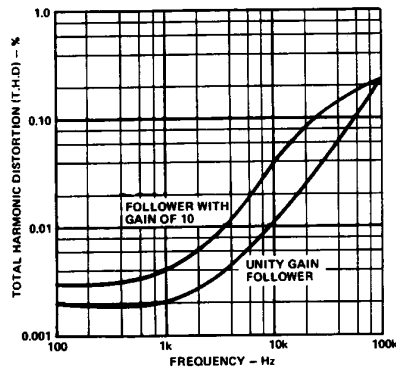


Figure 16. Total Harmonic Distortion vs. Frequency

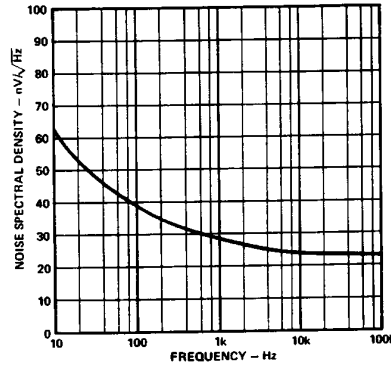


Figure 17. Input Noise Voltage Spectral Density

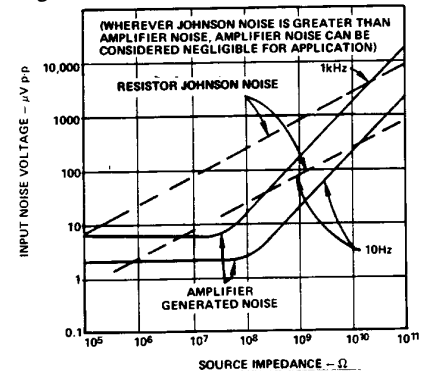
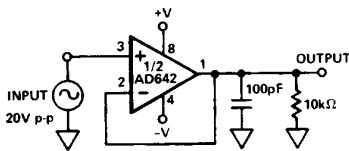
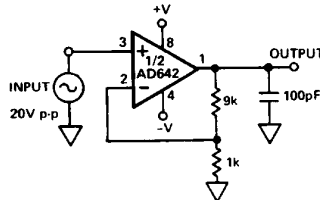


Figure 18. Total Noise vs. Source Impedance



a. Unity Gain Follower



b. Follower with Gain = 10

Figure 19. T. H. D. Test Circuits

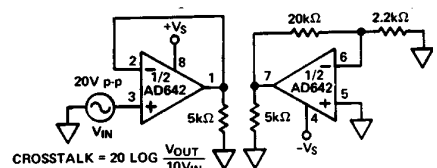


Figure 20. Crosstalk Test Circuit

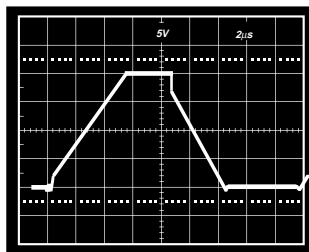


Figure 21a. Unity Gain Follower Pulse Response (Large Signal)

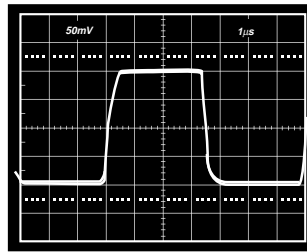


Figure 21b. Unity Gain Follower Pulse Response (Small Signal)

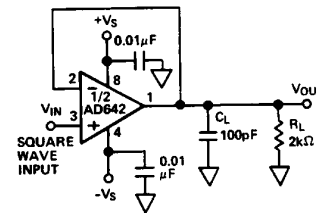


Figure 21c. Unity Gain Follower Pulse Response (Small Signal)

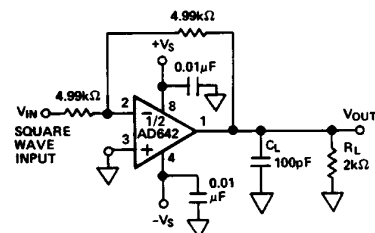


Figure 22a. Unity Gain Inverter

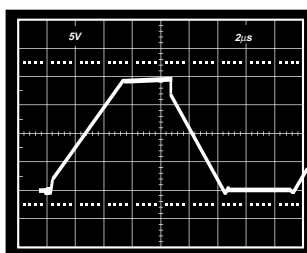


Figure 22b. Unity Gain Inverter Pulse Response (Large Signal)

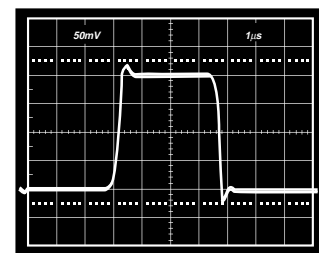


Figure 22c. Unity Gain Inverter Pulse Response (Small Signal)

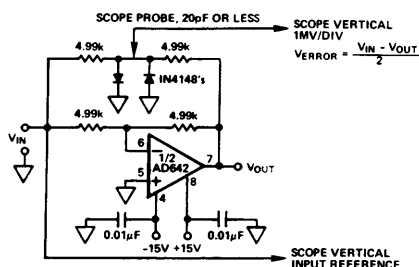


Figure 23. Settling Time Test Circuit

Fast settling time (8  $\mu$ s to 0.01% for 20 V p-p step), low power and low offset voltage make the AD642 an excellent choice for use as an output amplifier for current output D/A converters such as the AD7541.

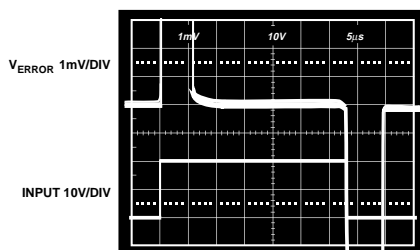
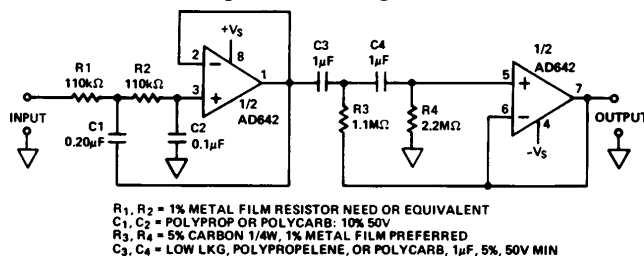


Figure 24. Settling Characteristic Detail

The upper trace of the oscilloscope photograph of Figure 24 shows the settling characteristic of the AD642. The lower trace represents the input to Figure 23. The AD642 has been designed for fast settling to 0.01%, however, feedback components, circuit layout and circuit design must be carefully considered to obtain optimum settling time.



# AD642

linearization of transducers having exponential outputs, and analog computing, ranging from simple translation of natural relationships in log form (e.g., computing absorbance as the log-ratio of input currents), to the use of logarithms in facilitating analog computation of terms involving arbitrary exponents and multiterm products and ratios.

The picoamp level input current and low offset voltage of the AD642 make it suitable for wide dynamic range log amplifiers. Figure 28 is a schematic of a log ratio circuit employing the AD642 that can achieve less than 1% conformance error over 5 decades of current input, 1 nA to 100  $\mu$ A. For voltage inputs, the dynamic range is typically 50 mV to 10 V for 1% error limited on the low end by the amplifier's input offset voltage.

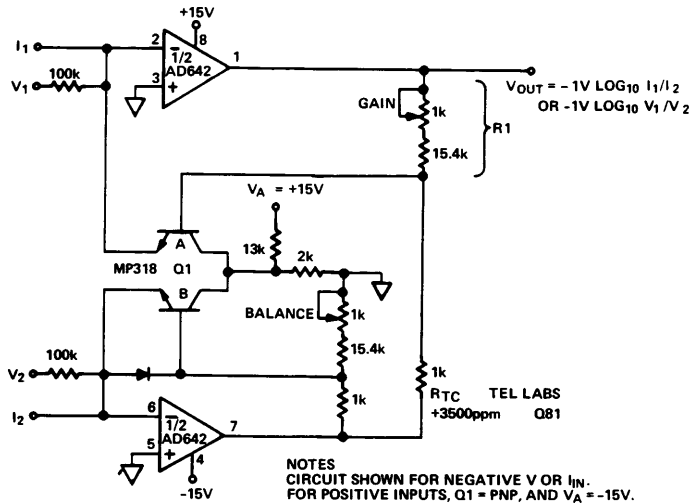


Figure 28. Log-Ratio Amplifier

The conversion between current (or voltage) input and log output is accomplished by the base emitter junctions of the dual transistor Q1. Assuming Q1 has  $\beta > 100$ , which is the case for the specified transistor, the base-emitter voltage on side 1 is to a close approximation:

$$V_{BEA} = kT/q \ln I_1/I_{S1}$$

This circuit is arranged to take the difference of the  $V_{BE}$ 's of Q1A and Q1B, thus producing an output voltage proportional to the log of the ratio of the inputs:

$$V_{OUT} = -K(V_{BEA} - V_{BEB}) = -\frac{KkT}{q} (\ln I_1/I_{S1} - \ln I_2/I_{S2})$$

$$V_{OUT} = -K kT/q \ln I_1/I_2$$

The scaling constant, K is set by R1 and  $R_{TC}$  to about 16, to produce 1 V change in output voltage per decade difference in input signals.  $R_{TC}$  is a special resistor with a +3500 ppm/ $^{\circ}$ C temperature coefficient, which makes K inversely proportional to temperature, compensating for the "T" in  $kT/q$ . The log-ratio transfer characteristic is therefore independent of temperature.

This particular log ratio circuit is free from the dynamic problems that plague many other log circuits. The -3 dB bandwidth is 50 kHz over the top 3 decades, 100 nA to 100  $\mu$ A, and decreases smoothly at lower input levels. This circuit needs no additional frequency compensation for stable operation from input current sources, such as photodiodes, that may have 100 pF of shunt capacitance. For larger input capacitances a 20 pF integration capacitor around each amplifier will provide a smoother frequency response.

The log ratio amplifier can be readily adjusted for optimum accuracy by following this simple procedure. First, apply  $V_1 =$

$V_2 = -10.00$  V and adjust "Balance" for  $V_{OUT} = 0.00$  V. Next apply  $V_1 = -10.00$  V,  $V_2 = -1.00$  V and adjust gain for  $V_{OUT} = +1.00$  V. Repeat this procedure until gain and balance readings are within 2 mV of ideal values.

The low input bias current (35 pA) and low noise characteristics of the AD642 make it suitable for electrometer applications such as photo diode preamplifiers and picoampere current-to-voltage converters. The use of guarding techniques in printed circuit board layout and construction is critical in printed circuit board layout and construction is critical for achieving the ultimate in low leakage performance that the AD642 can deliver. The input guarding scheme shown in Figure 29 will minimize leakage as much as possible; the guard ring should be applied to both sides of the board. The guard ring is connected to a low impedance potential at the same level as the inputs. High impedance signal lines should not be extended for any unnecessary length on a printed circuit; to minimize noise and leakage, they must be carried in rigid shielded cables.

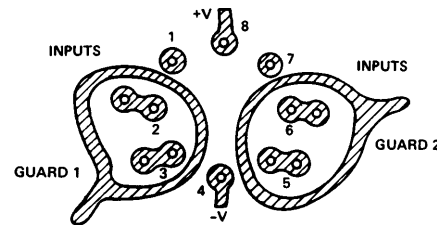


Figure 29. Board Layout for Guarding Inputs

## INPUT PROTECTION

The AD642 is guaranteed for a maximum safe input potential equal to the power supply potential. The input stage design also allows differential input voltages of up to  $\pm 0.5$  volts while maintaining the full differential input resistance of  $10^{12} \Omega$ . This makes the AD642 suitable for low speed voltage comparators directly connected to a high impedance source.

Many instrumentation situations, such as flame detectors in gas chromatographs, involve measurement of low level currents from high-voltage sources. In such applications, a sensor fault condition may apply a very high potential to the input of the current-to-voltage converting amplifier. This possibility necessitates some form of input protection. Many electrometer type devices, especially CMOS designs, can require elaborate Zener protection schemes which often compromise overall performance. The AD642 requires input protection only if the source is not current limited, and as such is similar to many JFET-input designs. The failure mode would be overheating from excess current rather than voltage breakdown. If the source is not current-limited, all that is required is a resistor in series with the affected input terminal so that the maximum overload current is 1.0 mA (for example, 100 k $\Omega$  for a 100 volt overload). This simple scheme will cause no significant reduction in performance and give complete overload protection. Figure 30 shows proper connections.

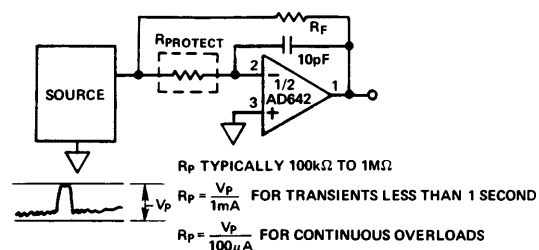


Figure 30. AD642 Input Protection

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[www.datasheetcatalog.com](http://www.datasheetcatalog.com)

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